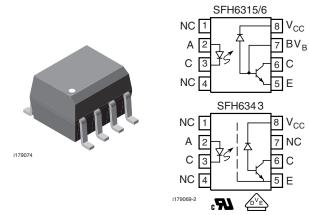


Vishay Semiconductors

COMPLIANT

# High Speed Optocoupler, 1 MBd, Transistor Output



#### **DESCRIPTION**

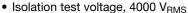
The SFH6315T, SFH6316T, SFH6343T, high speed optocouplers, each consists of a GaAlAs infrared emitting diode, optically coupled with an integrated photo detector and a high speed transistor. The photo detector is junction isolated from the transistor to reduce miller capacitance effects. The open collector output function allows circuit designers to adjust the load conditions when interfacing with different logic systems such as TTL, CMOS, etc.

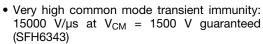
Because the SFH6343T has a faraday shield on the detector chip, it can also reject and minimize high input to output common mode transient voltages. There is no base connection, further reducing the potential electrical noise entering the package.

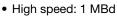
The SFH6315T, SFH6316T, SFH6343T are packaged in industry standard SOIC-8 packages and are suitable for surface mounting.

#### **FEATURES**

- Surface mountable
- Industry standard SOIC-8 footprint
- Compatible with infrared vapor phase reflow and wave soldering processes







- TTL compatible
- Guaranteed AC and DC performance temperature: 0 °C to 70 °C
- Open collector output
- Pin compatible with agilent (HP) optocouplers
  - SFH6315T HCPL0500
  - SFH6316T HCPL0501
  - SFH6343T HCPL0453
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

#### **APPLICATIONS**

- · Line receivers
- Logic ground isolation
- Analog signal ground isolation
- Replace pulse transformers

#### **AGENCY APPROVALS**

- UL1577, file no. E52744 system code Y
- cUL file no. E52744, equivalent to CSA bulletin 5A
- DIN EN 60747-5-5 (VDE 0884) available with option 1

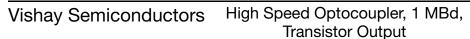
ORDERING INFORMATIO	N		
S F H	6 3	# # T	SIOC-8
	PART NUMBER		6.1 mm
AGENCY CERTIFIED/ PACKAGE		CTR (%)	
UL, cUL	≥ 5	≥ 15	NO BASE CONNECTION
SOIC-8	SFH6315T <sup>(1)</sup>	SFH6316T <sup>(1)</sup>	SFH6343T <sup>(1)</sup>

#### Note

(1) Also available in tubes; do not add T to end

ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT				
INPUT								
Reverse voltage		$V_R$	3	V				
DC forward current		I <sub>F</sub>	25	mA				
Surge forward current	$t_p \le 1 \mu s$ , 300 pulses/s	I <sub>FSM</sub>	1	Α				
Power dissipation	T <sub>amb</sub> ≤ 70 °C	P <sub>diss</sub>	45	mW				

# SFH6315T, SFH6316T, SFH6343T





<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
OUTPUT						
Supply voltage		Vs	- 0.5 to 30	V		
Output voltage		V <sub>O</sub>	- 0.5 to 25	V		
Output current		Ιο	8	mA		
Power dissipation	T <sub>amb</sub> ≤ 70 °C	P <sub>diss</sub>	100	mW		
COUPLER						
Isolation test voltage between emitter and detector		$V_{ISO}$	4000	$V_{RMS}$		
Pollution degree (DIN VDE 0110)			2			
Creepage distance			≥ 4	mm		
Clearance distance			≥ 4	mm		
Comparative tracking index per DIN IEC 112/VDE 0303 part 1		CTI	175			
Isolation resistance	V <sub>IO</sub> = 500 V, T <sub>amb</sub> = 25 °C, R <sub>ISOL</sub> <sup>(1)</sup>	R <sub>IO</sub>	≥ 10 <sup>12</sup>	Ω		
isolation resistance	$V_{IO} = 500 \text{ V}, T_{amb} = 100 \text{ °C}, R_{ISOL}$ (1)	R <sub>IO</sub>	≥ 10 <sup>11</sup>	Ω		
Storage temperature range		T <sub>stg</sub>	- 55 to + 150	°C		
Ambient temperature range		T <sub>amb</sub>	- 55 to + 100	°C		
Junction temperature		Tj	100	°C		
Soldering temperature (2)	max. 10 s, dip soldering distance to seating plane ≥ 1.5 mm		260	°C		

#### **Notes**

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
  implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
  maximum ratings for extended periods of the time can adversely affect reliability.
- (1) Device considered a two-terminal device: pins 1, 2, 3, and 4 shorted together and pins 5, 6, 7, and 8 shorted together.
- (2) Refer to reflow profile for soldering conditions for surface mounted devices.

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT	TEST CONDITION	FAIL	STWIDOL	IVIIIA.	1115.	IVIAA.	ONT
INF 01			V <sub>F</sub>		1.6	1.8	l v
Forward voltage	I <sub>F</sub> = 16 mA, 25 °C		V <sub>F</sub>		1.6	1.9	V
Deverage everyont	V 2V				0.5	1.9	-
Reverse current	V <sub>R</sub> = 3 V		I <sub>R</sub>			10	μA
Capacitance	$f = 1 \text{ MHz}, V_F = 0 \text{ V}$		C <sub>IN</sub>		75		pF
Temperature coefficient of	$I_F = 16 \text{ mA}$		$\Delta V_F$ /		- 1.7		mW/°C
OUTPUT							
Logic low supply current	$I_F = 16 \text{ mA}, V_O = \text{open}, V_{CC} = 15 \text{ V}$		I <sub>CCL</sub>		200		μΑ
Logio high oupply ourrent	$I_F$ = 0 mA, $V_O$ = open, $V_{CC}$ = 15 V; 25 °C		I <sub>CCH</sub>		0.001	1	μA
Logic high supply current			I <sub>CCH</sub>		0.001	2	μΑ
	$I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}, I_O = 1.1 \text{ mA},$	SFH6315T	V <sub>OL</sub>		0.15	0.4	V
	$I_F$ = 16 mA, $V_{CC}$ = 4.5 V, $I_O$ = 0.8 mA	SFH6315T	$V_{OL}$		0.15	0.5	V
Logic low output voltage	$I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}, I_O = 3 \text{ mA},$	SFH6316T	$V_{OL}$		0.15	0.4	V
Logic low output voltage	$I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}, I_O = 2.4 \text{ mA}$	SFH6343T	$V_{OL}$		0.15	0.5	V
	$I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}, I_O = 2.4 \text{ mA}$	SFH6316T	V <sub>OL</sub>		0.15	0.5	V
	$I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}, I_O = 2.4 \text{ mA}$	SFH6343T	V <sub>OL</sub>		0.15	0.5	V
	$I_F = 0 \text{ mA}, V_O = V_{CC} = 5.5 \text{ V}, 25 ^{\circ}\text{C}$		I <sub>OH</sub>		0.003	0.5	μΑ
Logic high output current	$I_F = 0 \text{ mA}, V_O = V_{CC} = 15 \text{ V}, 25 \text{ °C}$		I <sub>OH</sub>		0.01	1	μΑ
	$I_F = 0 \text{ mA}, V_O = V_{CC} = 15 \text{ V}$		I <sub>OH</sub>			50	μΑ



# High Speed Optocoupler, 1 MBd, Vishay Semiconductors Transistor Output

<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER TEST CONDITION PART SYMBOL MIN. TYP. MAX. UNIT						UNIT	
COUPLER							
Capacitance (input to output) (1)	f = 1 MHz		C <sub>IO</sub>		0.4		pF

#### Notes

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering
  evaluation. Typical values are for information only and are not part of the testing requirements.
- (1) A 0.1 µF bypass capacitor connected between pins 5 and 8 is recommended.

CURRENT TRANSFER RATIO							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Current transfer ratio	$V_O = 0.4 \text{ V}, I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}, 25 \text{ °C}$	SFH6315T	CTR	7	16	50	%
	$V_{O} = 0.5 \text{ V}, I_{F} = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}$	SFH6315T	CTR	5	17		%
	$V_{O} = 0.4 \text{ V}, I_{F} = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}, 25 ^{\circ}\text{C}$	SFH6316T	CTR	19	35	50	%
	$V_{O} = 0.4 \text{ V}, I_{F} = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}, 25 ^{\circ}\text{C}$	SFH6343T	CTR	19	35	50	%
	$V_{O} = 0.5 \text{ V}, I_{F} = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}$	SFH6343T	CTR	15	36		%
	$V_O = 0.5 \text{ V}, I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}$	SFH6316T	CTR	15	36		%

#### Note

Current transfer ratio in percent equals the ratio of output collector current (I<sub>O</sub>) to the forward LED input current (I<sub>F</sub>) times 100.
 A 0.1 μF bypass capacitor connected between pins 5 and 8 is recommended.

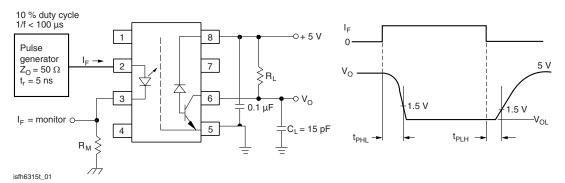


Fig. 1 - Test Circuit for Switching Times

SWITCHING CHARACTERISTICS							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
	$R_L = 4.1 \text{ K}\Omega$	SFH6315T	t <sub>PHL</sub> (1)		0.5	1.5	μs
Propagation delay time to logic		SFH6315T	t <sub>PHL</sub>		0.5	2	μs
low at output (see fig. 1)	R <sub>L</sub> = 1.9 KΩ	SFH6316T	t <sub>PHL</sub>		0.25	0.8	μs
		SFH6343T	t <sub>PHL</sub>		0.25	1	μs
	R <sub>L</sub> = 4.1 KΩ	SFH6315T	t <sub>PLH</sub> (1)		0.5	1.5	μs
Propagation delay time to logic high at output (see fig. 1)		SFH6315T	t <sub>PLH</sub>		0.5	2	μs
	$R_1 = 1.9 \text{ K}\Omega$	SFH6316T	t <sub>PLH</sub>		0.5	0.8	μs
		SFH6343T	t <sub>PLH</sub>		0.5	1	μs

#### Notes

- Over recommended temperature ( $T_{amb} = 0$  °C to 70 °C),  $V_{CC} = 5$  V,  $I_F = 16$  mA unless otherwise specified. The 1.9 kW load represents 1 TTL unit load of 1.6 mA and the 5.6 kW pull-up resistor. The 4.1 kW load represents 1 LSTTL unit load of 0.36 mA and the 6.1 kW pull-up resistor.
- $^{(1)}$   $T_{amb} = 25$  °C, unless otherwise specified.

## SFH6315T, SFH6316T, SFH6343T

# Vishay Semiconductors

### High Speed Optocoupler, 1 MBd, Transistor Output



COMMON MODE TRANSIENT IMMUNITY							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Common mode transient immunity at logic high level output (see fig. 2)	$\begin{aligned} R_L = 4.1 \text{ k}\Omega, I_F = 0 \text{ mA}, \\ V_{CM} = 10 \text{ V}_{P\text{-}P} \end{aligned}$	SFH6315T	CM <sub>H</sub>		1		kV/μs
	$R_L = 1.9 \text{ k}\Omega, I_F = 0 \text{ mA}, \\ V_{CM} = 1500 \text{ V}_{P-P}$	SFH6316T	CM <sub>H</sub>		1		kV/μs
		SFH6343T	CM <sub>H</sub>	15	30		kV/μs
Common mode transient	$\begin{aligned} R_L = 4.1 \text{ k}\Omega, I_F = 16 \text{ mA}, \\ V_{CM} = 10 \text{ V}_{P\text{-}P} \end{aligned}$	SFH6315T	CM <sub>L</sub>		1		kV/μs
	$\begin{aligned} R_L = 1.9 \text{ k}\Omega, I_F = 16 \text{ mA}, \\ V_{CM} = 10 \text{ V}_{P\text{-}P} \end{aligned}$	SFH6316T	CM <sub>L</sub>		1		kV/μs
output (666 lig. 2)	$R_L = 1.9 \text{ k}\Omega, I_F = 16 \text{ mA}, \ V_{CM} = 1500 \text{ V}_{P-P}$	SFH6343T	CM <sub>L</sub>	15	30		kV/μs

#### Note

Common mode transient immunity in a logic high level is the maximum tolerable (positive) dV<sub>CM</sub>/dt on the leading edge of the common mode
pulse (V<sub>CM</sub>) to assure that the output will remain in a logic high state (i.e., V<sub>O</sub> > 2 V). Common mode transient immunity in a logic low level
the maximum tolerable (negative) dV<sub>CM</sub>/dt on the trailing edge of the common mode pulse signal (V<sub>CM</sub> to assure that the output will remain
in logic low state, i.e., V<sub>O</sub> > 0.8 V).

The 1.9 k $\Omega$  load represents 1 TTL unit load of 1.6 mA and the 5.6 k $\Omega$  pull-up resistor.

The 4.1 k $\Omega$  load represents 1 LSTTL unit load of 0.36 mA and the 6.1 k $\Omega$  pull-up resistor.

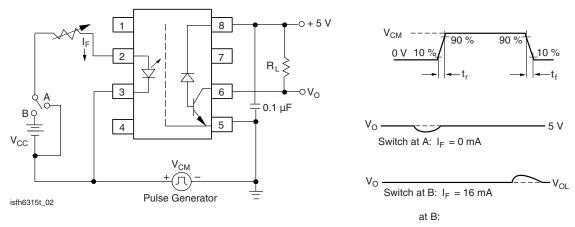


Fig. 2 - Test Circuit for Transient Immunity and Typical Waveforms

SAFETY AND INSULATION RATINGS							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Climatic Classification (according to IEC 68 part 1)				55/100/21			
Comparative Tracking Index		CTI	175		399		
V <sub>IOTM</sub>			6000			V	
V <sub>IORM</sub>			560			V	
P <sub>SO</sub>					350	mW	
I <sub>SI</sub>					150	mA	
T <sub>SI</sub>					165	°C	
Creepage distance			4			mm	
Clearance distance			4			mm	
Insulation thickness			0.2			mm	

#### Note

As per IEC 60747-5-5, §7.4.3.8.1, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with
the safety ratings shall be ensured by means of protective circuits.



# High Speed Optocoupler, 1 MBd, Vishay Semiconductors Transistor Output

#### TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

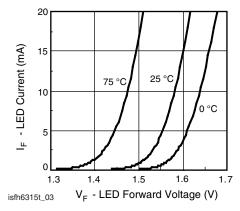


Fig. 3 - LED Forward Current vs. Forward Voltage

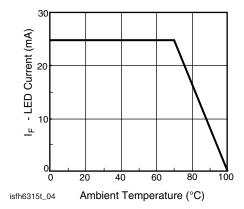


Fig. 4 - Permissible Forward LED Current vs. Temperature

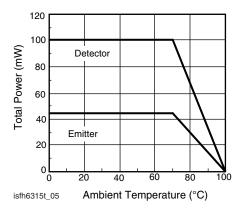


Fig. 5 - Permissible Power Dissipation vs. Temperature

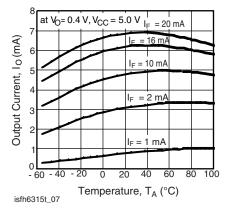


Fig. 6 - Output Current vs. Temperature

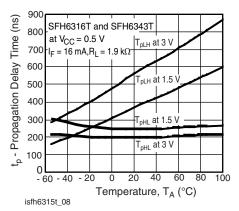


Fig. 7 - Propagation Delay vs. Temperature SFH6316T and SFH6343T

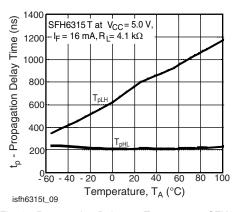


Fig. 8 - Propagation Delay vs. Temperature SFH6315T

# SFH6315T, SFH6316T, SFH6343T

# Vishay Semiconductors

### High Speed Optocoupler, 1 MBd, Transistor Output



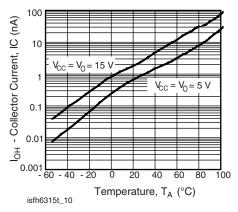


Fig. 9 - Logic High Output Current vs.Temperature

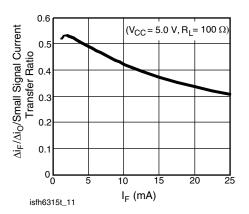
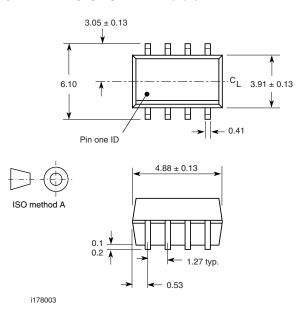
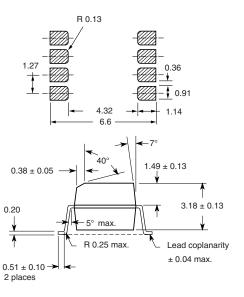


Fig. 10 - Small Signal Current Transfer Ratio vs. Input Current

#### **PACKAGE DIMENSIONS** in millimeters





#### **PACKAGE MARKING**





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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

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Revision: 02-Oct-12 Document Number: 91000

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SFH6315T SFH6316T SFH6343T